Specifications

- 1. RF Package should be suitable for assembly of high power dissipating Si, GaAs & GaN MMIC dice inside it.
- 2. Package material: a. Base: Cu-Mo-Cu, b. Frame: Fe-Ni-Co Alloy, c. Leads: Alloy 194
- 3. Lid Material: Fe-Ni-Co Alloy
- 4. Useable frequency range of the RF package: DC to 15 GHz (Minimum)
- 5. Detailed frequency response for the package to be provided by vendor along with quotation.
- 6. I/O connections: Package should contain minimum 2 RF ports and 8 DC ports as shown in package drawing.
- 7. RF & DC ports shall be made up of ceramic material with Microstrip-Stripline-Microstrip transitions. The transition shall be embedded in the

Fe-Ni-Co frame. The pins should be brazed to RF & DC ports outside package frame.

- 8. Plating on the Package & Lid: Ni with 2.54 µm minimum thickness + Au with 2.54 µm minimum thickness
- 9. Insulation Resistance: Leakage current $\leq 1.0 \times 10^{-7}$ Amps at 100 V DC
- 10. Package shall meet the Hermeticity of 1.0×10^{-8} atm.cc/sec
- 11. Vendor shall supply matched lid with suitable dimensions to match the package. The lid shall be seam/laser sealable to the package frame.
- 12. Vendor should provide the data sheet and drawing of the offered package and lid along with quotation.
- 13. Packing and marking:
- a) Package and lids shall be individually packed in suitable material and packing material shall not contain corrosive/out gassing elements.
- b) Packing shall be such that it should be physically restrained from vibration and shock in order to avoid any kind of damage to Packages and Lids.
- c) Containers shall be suitably packed for easy shipment, handling and storage without allowing damage to the parts.
- d) Container shall be marked with part number, lot number and quantity of Packages or Lids in each shipping container.
- e) Packing shall be such that no scratches should occur on Package and Lid during handling and transit.
- 14. Certificate of Conformance to the above specifications shall be provided for package and lid along with the items.

15. The package drawing (Tolerance:±0.2mm) is mentioned below. All dimensions are in mm.



Package Drawing



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0.15	-
0.38	
2.04	

5	LEAD	10	ALLOY 194
4	FRAME	1	Fe-Ni-Co ALLOY
З	BASE	1	Cu-Mo-Cu
2	DC FEEDTHRU	4	CERAMIC
1	RF FEEDTHRU	Z	CERAMIC
SL. NO.	DESCRIPTION	QTY.	MATL.